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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/773,879	02/06/2004	Gregory M. Chrysler	42.P12135D	7461	
75	7590 08/05/2004		EXAMINER		
Stephen M. De Klerk			NHU, DAVID		
Seventh Floor	KOLOFF, TAYLOR & 2	CAFMAN LLP	ART UNIT	PAPER NUMBER	
	12400 Wilshire Boulevard			· · · · · · · · · · · · · · · · · · ·	
Los Angeles, C	A 90025		DATE MAILED: 08/05/200	DATE MAILED: 08/05/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/773,879	CHRYSLER ET AL.			
Office Action Summary	Examiner	Art Unit)		
	David Nhu	2818	An		
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time y within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	ely filed s will be considered timely. the mailing date of this communic O (35 U.S.C. § 133).	eation.		
Status					
1)⊠ Responsive to communication(s) filed on <u>06 F</u>	ebruary 2004.				
2a) ☐ This action is FINAL . 2b) ☑ This	s action is non-final.				
	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims					
4) ⊠ Claim(s) <u>1-35</u> is/are pending in the application 4a) Of the above claim(s) <u>1-27</u> is/are withdrawn 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) <u>28-35</u> is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/or	n from consideration.				
Application Papers					
9) The specification is objected to by the Examine	er.				
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign a) ☐ All b) ☐ Some * c) ☐ None of: 1. ☐ Certified copies of the priority document 2. ☒ Certified copies of the priority document 3. ☐ Copies of the certified copies of the priority document application from the International Burea	ts have been received. ts have been received in Applicationity documents have been receive u (PCT Rule 17.2(a)).	on No. <u>09/920,275</u> . ed in this National Stage	•		
* See the attached detailed Office action for a list	·				
	Du	, Ra			
Attachment(s)					
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:				

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DETAIL ACTIONS

Specifications

Arrangement of the Specification

- 1. The following order or arrangement is preferred in framing the specification and, except for the reference to "Microfiche Appendix" and the drawings, each of the lettered items should appear in upper case, without underlining or bold type, as section headings. If no text follows the section heading, the phrase "Not Applicable" should follow the section heading:
 - (a) Title of the Invention.
 - (b) Cross-References to Related Applications.
 - (c) Statement Regarding Federally Sponsored Research or Development.
 - (d) Reference to a "Microfiche Appendix" (see 37 CFR 1.96).
 - (e) Background of the Invention.
 - 1. Field of the Invention.
 - 2. Description of the Related Art including information disclosed under 37 CFR 1.97 and 1.98.
 - (f) Brief Summary of the Invention.
 - (g) Brief Description of the Several Views of the Drawing(s).
 - (h) Detailed Description of the Invention.
 - (i) Claim or Claims (commencing on a separate sheet).
 - (j) Abstract of the Disclosure (commencing on a separate sheet).
 - (k) Drawings.
 - (I) Sequence Listing (see 37 CFR 1.821-1.825).

There is missing a Brief Summary of the Invention.

Also, page 12, line 12, "the package substrate 32" should be -- the package substrate 30--

Claims Objection

2. Claims 28-35, "a layer of **solid** diamond" is not described/supported in the specifications.

Claim Rejections - 35 USC § 112

3. Claim 32-35 are rejected under 35 U.S.C. 112, first paragraph, as containing subject matter which was not described in the specification in such a way as to reasonably convey to one

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skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

It appears that the original specification does not have support for "bonding a side of the monocrystalline semiconductor material through which the ions are implanted to the layer of material; serving a portion of the monocrystalline semiconductor material from a final portion thereof that is bonded to the layer of material as cited in claim 32", which were not described/supported in the specifications.

Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 5. Claims 28-29 are rejected under 35 U.S.C. 102 (b) as being anticipated by Ravi (5,131,963).

Regarding claim 28, Ravi, (see figures 2a-2g, 3, col. 4, lines 17-58), teach a method of making a plurality of dice, comprising: forming a layer of diamond 32 and a layer of monocrystalline semiconductor material 33 on one other; manufacturing a plurality of integrated circuits 34, 35 on the layer of monocrystalline semiconductor material; serving the layer of diamond 32 between the integrated circuits.

Regarding claim 29, Ravi, (see figures 1a-1g, col. 3, lines 5-67, figures 2a-2g, 3, 4a-4d, 5a-5d), also teach implanting ions a surface of a wafer of monocrystalline semiconductor material, the layer of diamond thereafter being located over the surface of the monocrystalline wafer; shearing a portion of the monocrystalline wafer implanted with the ions, the portion of the

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monocrysatlline wafer implanted with the ions forming the layer of monocrystalline semiconductor material.

Claim Rejections - 35 USC § 102

6. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 7. Claim 31 is rejected under 35 U.S.C. 102 (b) as being anticipated by Clevenger et al (6,337,513 B1).

Regarding claim 31, Clevenger, (see figures 6A-6F, col. 5, lines 59-67, col. 6, lines 1-26), teach a method of making a plurality of dice, comprising: forming a layer of diamond 62 on a wafer 60 of monocrystalline semiconductor material; grinding a portion of the monocrystalline semiconductor material; forming an epitaxial layer 67 (intermedia diamond layer) on the monocrystalline semiconductor material; forming a plurality of integrated circuits 60, 60' (chips) in and the epitaxial layer, to form a combination wafer (see figure 6F); and serving the combination wafer between the integrated circuits to singulated dice of the combination wafer from one another.

Conclusion

- 8. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Wood'546, Tanabe'063, Ogura'041, Nagy'665 are cited as of interest.
- 9. A shortened statutory period for response to this action is set to expired 3 (three) months from the date of this letter. Failure to respond within the period for response will cause the application to become abandoned (see 710.02 (b)).

Day Plan

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10. Any inquiry concerning this communication on earlier communications from the examiner should be directed to David Nhu, (571)272-1792. The examiner can normally be reached on Monday-Friday from 7:30 AM to 5:00 PM. The examiner's supervisor, David Nelms can be reached on (571)272-1787.

The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

David Nhu

Dal

August 2nd, 2004